

Description

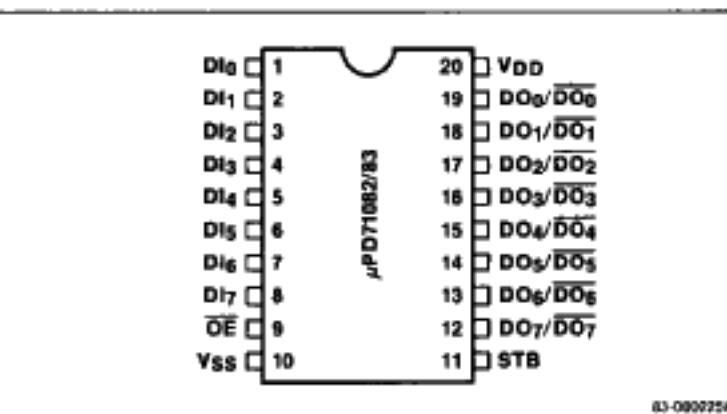
μ PD71082 and μ PD71083 are CMOS 8-bit transparent latches with three-state output buffers. They are used as bus buffers or bus multiplexers in microprocessor systems. Their high-drive capability makes them suitable for data latch, buffer, or I/O port applications.

Features

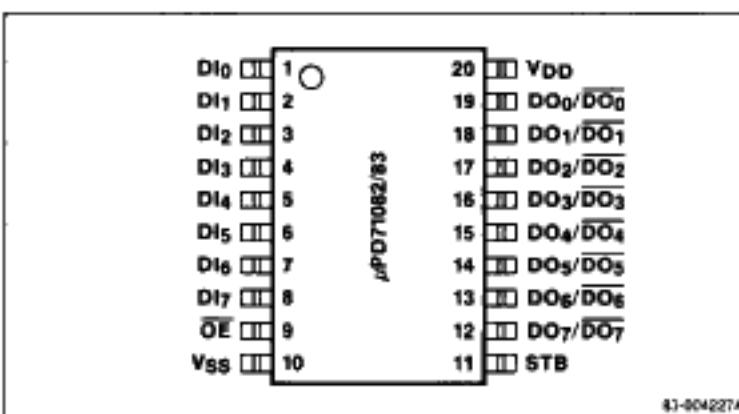
- CMOS technology
- 8-bit parallel data register
- Three-state output buffer
- High drive capability output buffer ($I_{OL} = 12$ mA)
- μ PD8085A, 8048, 8086, 8088, μ PD70108/116, and μ PD70208/216 system compatible
- μ PD71082 — non-inverted output; μ PD71083 — inverted output
- Single +5 V $\pm 10\%$ power supply
- Transparent operation
- Industrial temperature range: -40 to +85°C

Ordering Information

Part Number	Package	Output
μ PD71082C	20-pin plastic DIP	Non-inverted
μ PD71082G	20-pin plastic SOP	
μ PD71083C	20-pin plastic DIP	Inverted
μ PD71083G	20-pin plastic SOP	

Pin Configurations**20-Pin Plastic DIP**

8J-090025A

20-Pin Plastic SOP

8J-004227A

5h

Pin Identification

Symbol	Function
DI ₀ -DI ₇	Data input, bits 0-7
DO ₀ -DO ₇ /DO ₀ -DO ₇	Data output, bits 0-7; non-inverted (μ PD71082) or inverted (μ PD71083)
STB	Strobe input
OE	Output enable input
V _{DD}	+5 V power supply
V _{SS}	Ground

PIN FUNCTIONS**DI₀-DI₇ (Data Input)**

DI₀-DI₇ are data input lines to the 8-bit data latch. Data on DI lines passes through the latch while STB is high. The data is latched to DO/DO with the falling edge of STB.

DO₀-DO₇/D̄O₀-D̄O₇ (Data Output)

DO₀-DO₇/D̄O₀-D̄O₇ are the three-state data output lines from the 8-bit data latch. When OE is high, these lines go into the high-impedance state. When OE is low, data from the latch is output, either non-inverted (μPD71082) or inverted (μPD71083).

STB (Strobe)

STB is the input strobe signal for the 8-bit latch. When STB is high, data on the DI lines passes through the 8-bit

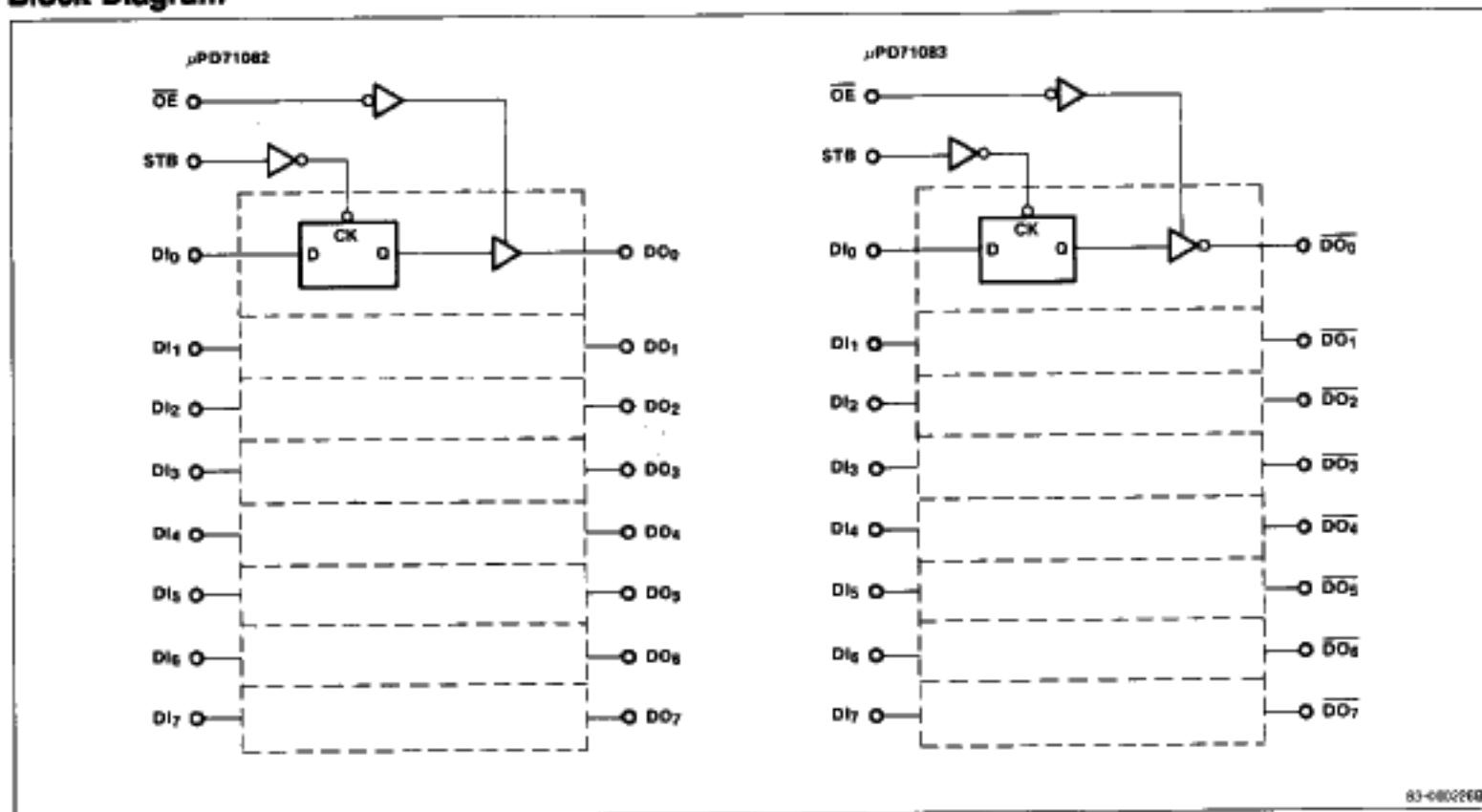
latch. Data is latched on the falling edge of STB. When STB is low, the DO₀-DO₇/D̄O₀-D̄O₇ outputs do not change.

OE (Output Enable)

OE input is the output enable signal for the three-state DO/DO lines. When OE is high, DO/DO lines are high impedance. When OE is low, data from the 8-bit latch is output to DO₀-DO₇/D̄O₀-D̄O₇. See table 1.

Table 1. Latch Operation

STB	OE	DO ₀ -DO ₇ /D̄O ₀ -D̄O ₇	8-Bit Data Latch
Low	Low	Latched data from 8-bit data latch is enabled	DI line data has been latched with falling edge of STB (high to low)
	High	High Impedance	
High	Low	Data on DI ₀ -DI ₇	DI passed through to DO/DO
	High	High Impedance	

Block Diagram

FUNCTIONAL DESCRIPTION

The μPD71082 and μPD71083 are 8-bit data latches strobed by the STB signal. They have high-drive capability output buffers controlled by the OE signal. Data on the DI lines is latched by the trailing edge of STB (high to low). When STB is high, data passes through the latch. When OE is high, DO lines are high impedance. When OE is low, the contents of the latches are output on DO₀-DO₇. The DO lines are isolated from OE switching noise.

ELECTRICAL SPECIFICATIONS

Absolute Maximum Ratings

$T_A = 25^\circ\text{C}$; $V_{SS} = 0\text{ V}$	
Power supply voltage, V_{DD}	-0.5 to +7.0 V
Input voltage, V_I	-1.0 to $V_{DD} + 1\text{ V}$
Output voltage, V_O	-0.5 to $V_{DD} + 0.5\text{ V}$
Power dissipation, $P_{D\text{MAX}}$, DIP	500 mW
Power dissipation, $P_{D\text{MAX}}$, SO	200 mW
Operating temperature, T_{opt}	-40 to +85°C
Storage temperature, T_{stg}	-65 to +150°C

Exposing the device to stresses above those listed in the absolute maximum ratings could cause permanent damage. Exposure to absolute maximum ratings for extended periods may affect device reliability.

DC Characteristics

$T_A = -40$ to $+85^\circ\text{C}$; $V_{DD} = 5\text{ V} \pm 10\%$

Parameter	Symbol	Min	Max	Units	Conditions
Input voltage, high	V_{IH}	2.2	V	$V_{OL} = 0.45\text{ V}$ $V_{OH} = V_{DD} - 0.8\text{ V}$	
Input voltage, low	V_{IL}	0.8	V	$V_{OL} = 0.45\text{ V}$ $V_{OH} = V_{DD} - 0.8\text{ V}$	
Output voltage, high	V_{OH}	$V_{DD} - 0.8$	V	$I_{OH} = -4\text{ mA}$	
Output voltage, low	V_{OL}	0.45	V	$I_{OL} = 12\text{ mA}$	
Input current	I_I	-1.0	1.0	μA	$V_I = V_{DD}, V_{SS}$
Leakage current, high impedance	I_{OFF}	-10	10	μA	$\overline{OE} = V_{DD}$
Power supply current (static)	I_{DD}	80	μA	$V_I = V_{DD}, V_{SS}$	
Power supply current (dynamic)	$I_{DD\text{dyn}}$	20	mA	$f_{IN} = 10\text{ MHz}$ $C = 200\text{ pF}$	

Capacitance

$T_A = 25^\circ\text{C}$; $V_{DD} = +5\text{ V}$

Parameter	Symbol	Min	Max	Units	Conditions
Input capacitance	C_{IN}		12	pF	$f = 1\text{ MHz}$

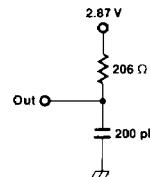
AC Characteristics

$T_A = -40$ to $+85^\circ\text{C}$; $V_{DD} = 5\text{ V} \pm 10\%$

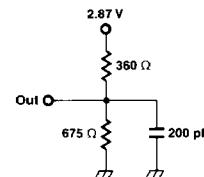
Parameter	Symbol	Min	Max	Units	Conditions
Input to output delay	t_{DIO}	5	40	ns	Loading circuit (a)
STB to output delay	t_{DSTB0}	10	60	ns	
Data float time from OE high	t_{FCT0}	5	30	ns	Loading circuit (b)
Data output delay from OE low	t_{DCT0}	10	40	ns	
Input to STB setup time	t_{SISTB}	0		ns	Loading circuit (a)
Input to STB hold time	t_{HSTB1}	25		ns	
STB high pulse width	t_{PWSTB}	20		ns	
Signal rise time	t_{LH}		20	ns	0.8 to 2.0 V
Signal fall time	t_{HL}		12	ns	2.0 to 0.8 V

Loading Circuits for AC Testing

[a] VOL, VOH Outputs



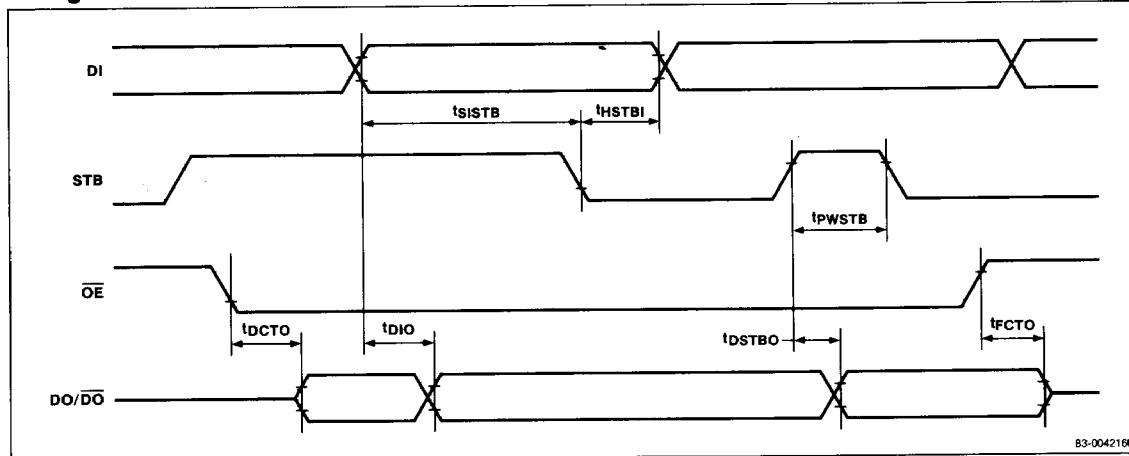
[b] Three-State Output



Loading Conditions: $I_{OL} = 12\text{ mA}$, $I_{OH} = 4\text{ mA}$, $C_L = 200\text{ pF}$

83-000228A

Timing Waveforms



Timing Measurement Points

